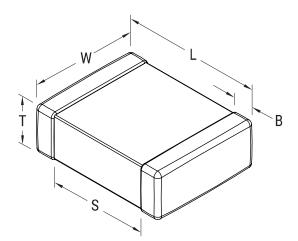


C0805C334M3RAC7210

SMD Comm X7R, Ceramic, 0.33 uF, 20%, 25 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 0805, 0.7 mm



Click here for the 3D model.

General Information		
Series	SMD Comm X7R	
Style	SMD Chip	
Description	SMD, MLCC, Temperature Stable, Class II	
Features	Temperature Stable, Class II	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	21 mg	
Shelf Life	78 Weeks	
MSL	1	

	Specifications	
0805	Capacitance	0.33 uF
2mm +/-0.2mm	Measurement Condition	1 kHz 1.0Vrms
1.25mm +/-0.2mm	Tolerance	20%
1.25mm +/-0.15mm	Voltage DC	25 VDC
0.7mm MIN	Dielectric Withstanding Voltage	62.5 VDC
0.5mm +/-0.25mm	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
T&R, 330mm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
10000	Dissipation Factor	3.5%1 kHz 1.0Vrms
	Aging Rate	3% Loss/Decade Hour: Refere Time is 1000 Hours

Insulation Resistance

1.5152 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Dimensions

**Packaging Specifications** 

Packaging Quantity

Chip Size

L W

Т

s

В

Packaging

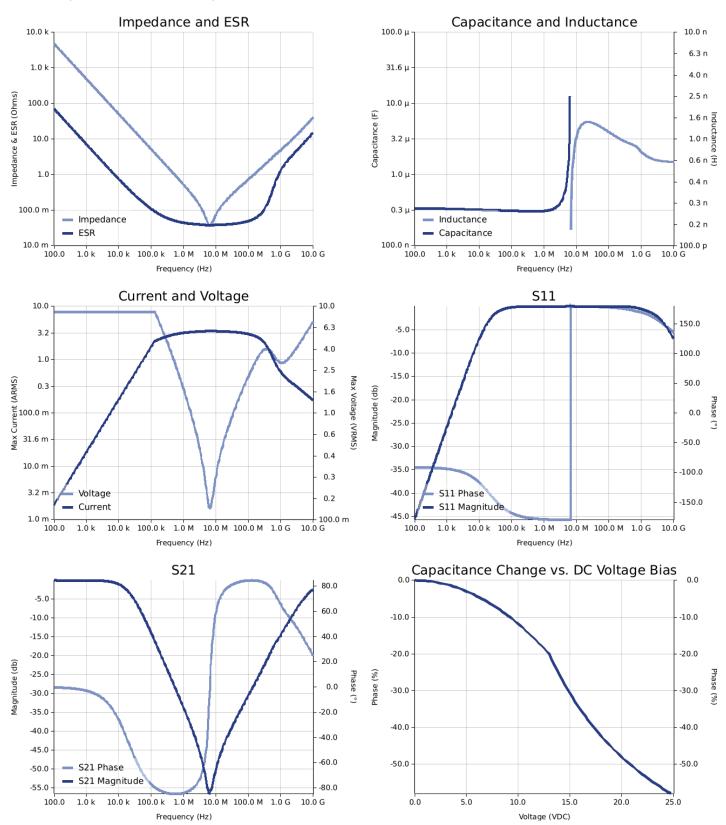
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CO805C334M3RAC7210 SMD Comm X7R, Ceramic, 0.33 uF, 20%, 25 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 0805, 0.7 mm

## Simulations

For the complete simulation environment please visit K-SIM.





## These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for hipple klipple current younge vs. requericy plots is the ESR at an bient temperature.
  The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
  The effects shown herein are based on measured data from a multiple part sample of the parts in question.
  Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
  The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages are not combined with voltages.
- generated at any other harmonics.
  Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.